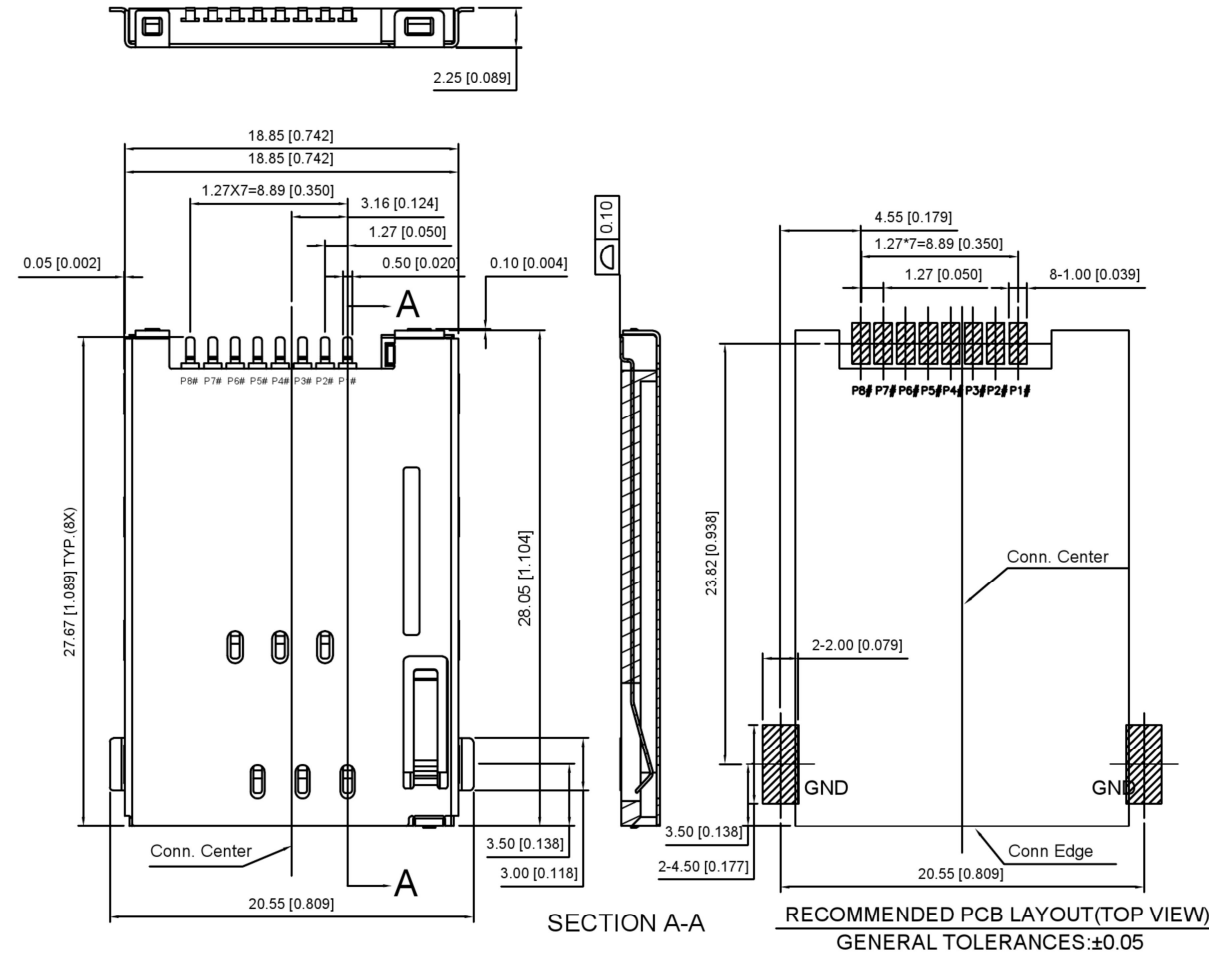




Specification

* Electrical Characteristics :

Current Rating: 0.5A AC/DC Max.

Dielectric Withstanding Voltage: 250V AC/DC

Insulation Resistance: 500M ohms Min.

Contact Resistance: 100m ohms Max.

*Mechanical Characteristics:

Mating Cycles: 5000 Insertions.

* Environmental :

Operating Temperature:-40°C to +85°C.

* Material:

1.Housing:HI-Temp plastic UL 94V-0 Rated.

2.Contact:Copper Alloy.

3.Shell:Stainless Steel,t=0.20mm.

* Plating :

Terminal:

Contact area: G/F Plated Over Nickel.

Solder area: Tin Plated Over Nickel.

Under plate: Nickel.

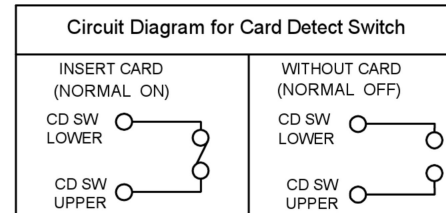
Shell:

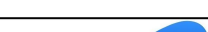
Nickel Plated Over All,

Solder Area: Gold Flash.

PIN NO.	DESCRIPTION
P1#	C1:VCC
P2#	C5:GND
P3#	C2:RST
P4#	C6:VPP
P5#	C3:CLK
P6#	C7:I/O
P7#	CD SW LOWER
P8#	CD SW UPPER

ITEM	PART NAME	QTY	MATERIAL	FINISHING
③	Shell	1	SUS	
②	Terminal	8	COPPER ALLOY	
①	Housing	1	HI-TEMP. PLASTIC UL 94V-0	BLACK



							DSND		SCALE: N/A	MODEL TYPE: SIM CARD CONN		
				ANGLAR	±5°		DWN		VIEW: 	PART NO.: XKSIM-010		
				L ≤ 4	±0.2		CHKD		UNIT: mm/in	DWG NO.:		
				4 < L ≤ 16	±0.3		APPD		SIZE: A4			
				16 < L ≤ 63	±0.4							
				L > 63	±0.5							
				DATE	REVISED	APPROVED						
REVISIONS						UNSPECIFIED TOLERANCES						
www.alpsr.com www.gdxjdz.com www.xbswitch.com						DONG GUAN XI BANG ELECTRONIC CO., LTD			WEIGHT	SHEET	REVISION	
										1/1	A0	